501798560 01/26/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masafumi KUNIEDA	01/17/2012
Yosuke MATSUKAWA	01/17/2012

RECEIVING PARTY DATA

Name:	IBIDEN CO., LTD.	
Street Address:	1, Kandacho 2-Chome, Ogaki-Shi	
City:	Gifu	
State/Country:	JAPAN	
Postal Code:	503-8604	

PROPERTY NUMBERS Total: 1

	Property Type	Number
Applica	tion Number:	13327756

CORRESPONDENCE DATA

Fax Number:(703)519-9958Phone:703-519-9953

Email: MNakai@dcpatent.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: Masayasu Mori
Address Line 1: 918 PRINCE STREET
Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: P5878US00

NAME OF SUBMITTER: Masayasu Mori

Total Attachments: 2

source=2012-01-03_NFMP_P5878US00_Assignment#page1.tif source=2012-01-03_NFMP_P5878US00_Assignment#page2.tif

PATENT

REEL: 027595 FRAME: 0950

OF \$40.00 1332//56

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned, _(1) Masafumi KUNIEDA, residing at Ibi-Gun, Gifu, Japan and (2) Yosuke MATSUKAWA, residing at Ibi-Gun, Gifu, Japan, hereby sell, assign, and transfer to IBIDEN CO., LTD., a corporation of Japan having a principal place of business at 1. Kandacho 2-Chome, Ogaki-Shi, Gifu 503-8604 Japan ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements that are disclosed in the application for the United States patent, entitled:

HONEYCOMB STRUCTURE, METHOD OF MANUFACTURING HONEYCOMB STRUCTURE, AND EXHAUST GAS CONVERTER

☐ which has been executed by the undersigned concurrently herewith,				
which was filed on	December 16, 2011	and assigned Serial No.	13/327,756	

and in to said application and all divisional, continuing, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

agree that said Assignee may apply for and receive a patent or patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all assignments and powers of attorney; communicate to said Assignee, its successors, assigns, and representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or representatives in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Please Sign and Date Below:

January 17 ,20 12	Masafini Kineda	
Date	Name: Masafumi KUNIEDA	
January 17 ,20_12_	Yosuke Matukawa	
Date	Name: Yosuke MATSUKAWA	